#### **ATXAIG-H12**

Request Samples



Check Inventory (>)



2.5 x 2.0 x 1.0 mm **RoHS/RoHS II Compliant** MSL Level = 1

#### **Features**

- AEC-Q200 Qualified
- TS16949 Production Line Certified
- PPAP Available Upon Request
- Both continuous & fixed Vdd options available

# **Applications**

- Cellular and cordless phones
- Standard oscillator for exact equipment
- Consumer electronics
- Industrial control & automation
- Mobile communication

## Electrical Specifications [Note 1]

Parameters	Min.	Тур.	Max.	Units	Notes
Frequency Range	8.0		70	MHz	
Operating Temperature	-40		+85	°C	See Options (Table 1)
Storage Temperature	-55		+125	°C	
Frequency Stability $\Delta f/f_o$ vs:					
	rance -1.0		+1.0		Reference to f <sub>o</sub> , at 25°C±2°C, Pre-reflow
Tole	rance -2.0		+2.0		Reference to f <sub>o</sub> , at 25°C ±2°C, 24 hours after reflow, two times
Temper	rature -2.5		+2.5	ppm	See Options (Table 1) Reference to f <sub>o</sub> , at 25°C ±2°C
Supply Voltage Cl	hange -0.3		+0.3		Vdd ± 5%
Load Ci			+0.2		
Aging	-1.0		+1.0		First year @+25°C±2°C
	+3.135	+3.3	+3.465		Option E
	+2.85	+3.0	+3.15		Option A
Supply Voltage (Vdd)	+2.66	+2.8	+2.94	V	Option B
Supply voltage (vdd)	+2.375	+2.5	+2.625	v	Option C
	+1.71	+1.8	+1.89		Option D
	+1.68		+3.63		Option F
Supply Current (Idd)			10	mA	
Start-up Time			2	ms	
Rise and Fall Time (Tr/Tf) @10%Vdd-90%Vdd, 15pF load			5	ns	
Symmetry @ ½ Vdd	45	50	55	%	
Vou	90%Vdd			V	
Output Voltage Vol.			10%Vdd	v	
Output Load			15	pF	CMOS
Output Waveform		CMOS			
Tri-state function [Note 2]		"1" (VIH≥0.7*Vdd) or Open: Oscillation; "0" (VIL<0.3*Vdd): No Oscillation/Hi Z			

All measurements made at 25°C ±2°C, nominal Vdd, unless otherwise specified

Do not leave pin 1  $(\overline{\text{INH}})$  floating. If pin 1  $(\overline{\text{INH}})$  is not utilized for toggling, it must be tied to Vdd (logic 1). Note 2:



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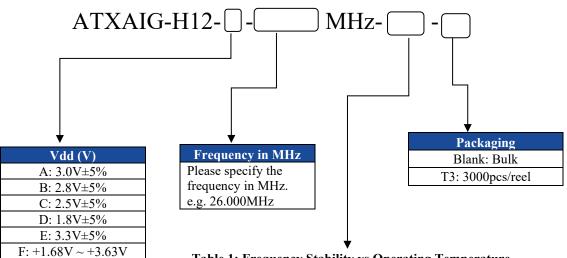


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#### **Part Identification**



**Table 1: Frequency Stability vs Operating Temperature** 

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	±2.5ppm	±3.0ppm	±4.0ppm	±5.0ppm		
0°C ~ +70°C	A25	A30	A40	A50		
-10°C ~ +60°C	B25	B30	B40	B50		
-20°C ~ +70°C	C25	C30	C40	C50		
-30°C ~ +75°C	D25	D30	D40	D50		
-30°C ~ +85°C	E25	E30	E40	E50		
-40°C ~ +85°C	F25	F30	F40	F50		



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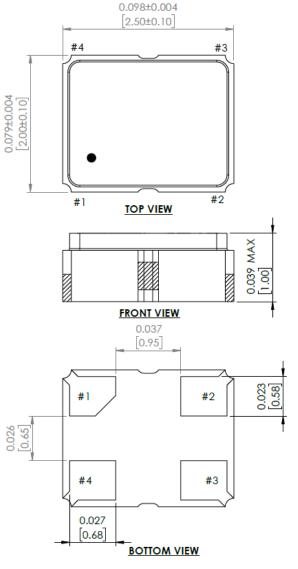


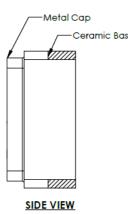


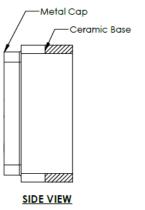


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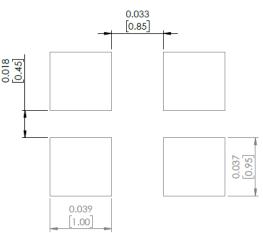
## **Mechanical Dimensions**







## Recommended Land Pattern



Pin #	Function		
1	ĪNĦ		
2	GND		
3	Output		
4	Vdd		

INH Function				
#1 #3 (Output)				
Open	Active			
"H" Level	Active			
"L" Level	High Z (No Oscillation)			

- -Do not leave Pin 1 (INH) floating
- -If Pin 1 (INH) is not utilized for toggling, it must be tied to Vdd (logic 1)

#### Note 4:

Recommended to use approximately 0.01µF bypass capacitor between PIN 2 and PIN 4

**Dimensions: inches (mm)** 



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# **Reflow Profile [JDEC J-STD-020]**

T<sub>p</sub>

 $T_{L^{\prime}}$ 

Temperature

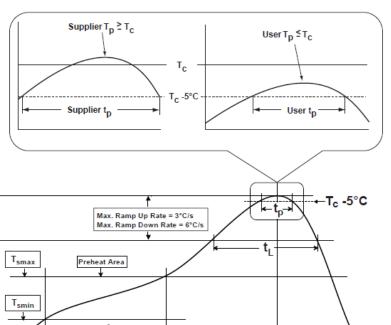


Table 1

SnPb Eutectic Process Classification Temperatures (Tc)				
Package Thickness	Volume mm <sup>3</sup> <350	Volume mm³ ≥350		
<2.5 mm	235 °C	220 °C		
≥2.5 mm	220 °C	220 °C		

Table 2

Classification Temperatures (T <sub>c</sub> )				
Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000	
<1.6 mm	260 °C	260 °C	260 °C	
1.6 mm - 2.5 mm	260 °C	250 °C	245 °C	
>2.5 mm	250 °C	245 °C	245 °C	

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat / soak		
Temperature minimum (T <sub>smin</sub> )	100°C	150°C
Temperature maximum (T <sub>smax</sub> )	150°C	200°C
Time $(T_{smin} \text{ to } T_{smax})$ $(t_s)$	60 - 120 sec.	60 - 120 sec.
Average ramp-up rate $(T_{smax} \text{ to } T_P)$	3°C/sec. max	3°C/sec. max
Liquidous temperature (T <sub>L</sub> )	183°C	217°C
Time at liquidous (t <sub>L</sub> )	60 - 150 sec.	60 - 150 sec.
Peak package body temperature (T <sub>P</sub> )*	see Table 1	see Table 2
Time $(t_p)^{**}$ within 5°C of the specified classification temperature $(T_C)$	20 sec.	30 sec.
Ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )	6°C/sec. max	6°C/sec. max
Time 25°C to peak temperature	6 min. max	8 min. max

<sup>\*</sup>Tolerance for peak profile temperature (TP) is defined as a supplier minimum and a user maximum.



Time 25°C to Peak

<sup>\*\*</sup>Tolerance for time at peak profile temperature (tp) is defined as supplier minimum and a user maximum.

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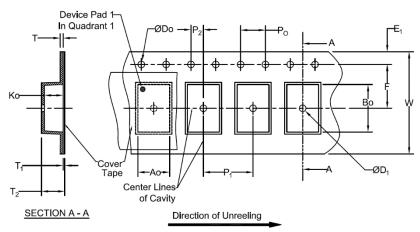
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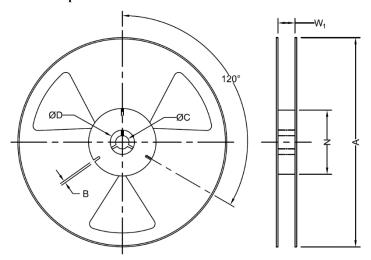
#### **Packaging**

#### T3: 3,000pcs/reel



Tape Specifications (mm) Width Bo D<sub>1</sub> (Min) F  $E_1$ Do Ko Αo 8mm 1.5+0.1/-0.0 1.75±0.1 3.5±0.05 1.0  $\mathbf{P}_1$ P<sub>2</sub>  $P_0 \\$ T (Max) W (Max) Width T<sub>1</sub> (Max) T<sub>2</sub> (Max)  $4.0 \pm 0.1$  $2.0\pm0.05$ 4.0±0.1 0.6 2.5 8.3 8mm 0.1

\*Note: Compliant to EIA-481



Reel Specifications (mm)							
Width	Width Oty/Reel A B C (Min) D N *W <sub>1</sub>						
8mm	3000	178	1.5	13.0+0.5/-0.2	20.2	50	8.4+1.5/-0.0

\*Note: Measured at Hub

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